

Description

The HD6758-F uses advanced trench technology

to provide excellent R_{DS(ON)}, low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a

Battery protection or in other Switching application.

D S S

TO-252-2L

General Features

 $V_{DS} = 40V I_{D} = 60A$

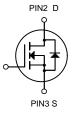
 $R_{DS(ON)}$ < 8.5m Ω @ V_{GS} =10V

Application

Battery protection

Load switch

Uninterruptible power supply



N-Channel MOSFET

Package Marking and Ordering Information

| Product ID | Pack | Marking | Qty(PCS) |
|------------|----------|----------------|----------|
| HD6758-F | TO252-2L | HD6758 XXX YYY | 2500 |

Absolute Maximum Ratings (T_c=25 ℃ unless otherwise noted)

| Symbol | Parameter | Rating | Units | |
|---------------------------------------|---|--|-------|--|
| Vps | Drain-Source Voltage | 40 | V | |
| Vgs | Gate-Source Voltage | ±20 | V | |
| I _D @T _C =25°C | Continuous Drain Current, V _{GS} @ 10V ¹ | nuous Drain Current, V _{GS} @ 10V ¹ 60 | | |
| I _D @T _C =100°C | Continuous Drain Current, V _{GS} @ 10V ¹ | А | | |
| Ідм | Pulsed Drain Current ² | 220 | А | |
| EAS | Single Pulse Avalanche Energy ³ 416.1 | | mJ | |
| las | Avalanche Current | Avalanche Current 39 | | |
| P _D @T _C =25°C | Total Power Dissipation ⁴ | 64.6 | W | |
| Тѕтс | Storage Temperature Range | Range -55 to 150 | | |
| TJ | Operating Junction Temperature Range | erature Range -55 to 150 | | |
| ReJA | Thermal Resistance Junction-ambient (Steady State) ¹ | 62 | °C/W | |
| R₀JC | Thermal Resistance Junction-Case ¹ | 2.8 | °C/W | |



Electrical Characteristics (T_C=25°C unless otherwise noted)

| Parameter | Symbol | Condition | Min | Тур | Max | Unit | |
|------------------------------------|---------------------|--|-----|------|------|------|--|
| Off Characteristics | | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V I _D =250μA | 40 | 45 | - | V | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =40V,V _{GS} =0V | - | - | 1 | μA | |
| Gate-Body Leakage Current | I _{GSS} | V _{GS} =±20V,V _{DS} =0V | - | - | ±100 | nA | |
| On Characteristics (Note 3) | | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS}=V_{GS},I_{D}=250\mu A$ | 1.2 | 1.6 | 2.0 | V | |
| Drain Course On State Besistance | | V _{GS} =10V, I _D =20A | - | 7.0 | 8.5 | 0 | |
| Drain-Source On-State Resistance | R _{DS(ON)} | V _{GS} =4.5V, I _D =20A | | 15 | 18 | mΩ | |
| Forward Transconductance | g FS | V _{DS} =10V,I _D =20A | 15 | - | - | S | |
| Dynamic Characteristics (Note4) | | | | | | | |
| Input Capacitance | C _{lss} | V _{DS} =20V,V _{GS} =0V, F=1.0MHz | - | 1800 | - | PF | |
| Output Capacitance | Coss | | - | 280 | - | PF | |
| Reverse Transfer Capacitance | C _{rss} | F=1.0WHZ | - | 190 | - | PF | |
| Switching Characteristics (Note 4) | | | | | | | |
| Turn-on Delay Time | t _{d(on)} | | - | 6.4 | - | nS | |
| Turn-on Rise Time | t _r | V_{DD} =20 V , I_D =2 A , R_L =1 Ω | - | 17.2 | - | nS | |
| Turn-Off Delay Time | t _{d(off)} | V_{GS} =10 V , R_{G} =3 Ω | - | 29.6 | - | nS | |
| Turn-Off Fall Time | t _f | | - | 16.8 | - | nS | |
| Total Gate Charge | Qg | V -20VI -20A | - | 29 | | nC | |
| Gate-Source Charge | Q _{gs} | V _{DS} =20V,I _D =20A, V _{GS} =10V | - | 4.5 | | nC | |
| Gate-Drain Charge | Q _{gd} | VGS-10V | - | 6.4 | | nC | |
| Drain-Source Diode Characteristics | · | | | | | | |
| Diode Forward Voltage (Note 3) | V _{SD} | V _{GS} =0V,I _S =10A | - | | 1.2 | V | |
| Diode Forward Current (Note 2) | Is | | - | - | 68 | Α | |
| Reverse Recovery Time | t _{rr} | TJ = 25°C, IF = 20A | - | 29 | - | nS | |
| Reverse Recovery Charge | Qrr | di/dt = 100A/µs ^(Note3) | - | 26 | - | nC | |
| Forward Turn-On Time | t _{on} | Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD) | | | | | |

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300 µs, Duty Cycle ≤ 2%.
- **4.** Guaranteed by design, not subject to production
- **5.** E_{AS} condition : $Tj=25^{\circ}C$, $V_{DD}=20V$, $V_{G}=10V$,L=1mH, $Rg=25\Omega$,





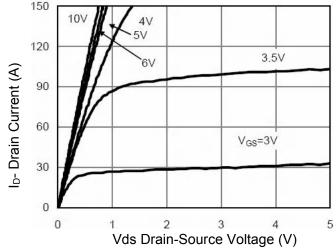


Figure 1 Output Characteristics

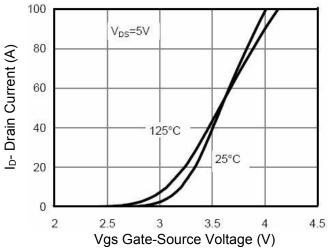


Figure 2 Transfer Characteristics

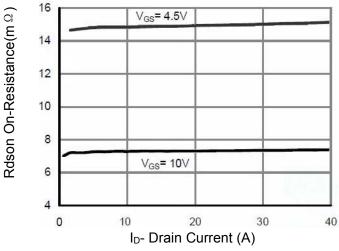


Figure 3 Rdson- Drain Current

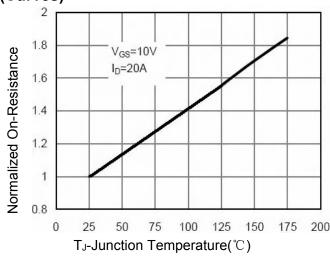


Figure 4 Rdson-JunctionTemperature

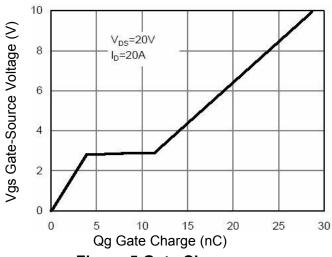


Figure 5 Gate Charge

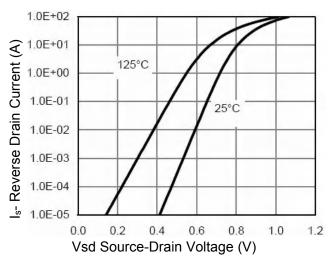
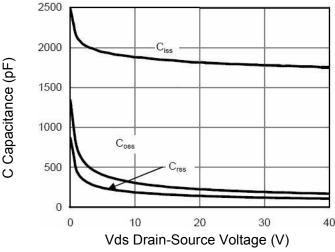


Figure 6 Source- Drain Diode Forward

175





Power Dissipation (W) 30 20 10 0 50 100 150 40 0 25 75 125 T_J-Junction Temperature (°C)

70

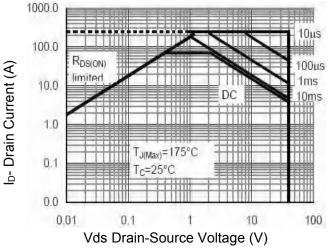
60

50

40

Figure 7 Capacitance vs Vds

Figure 9 Power De-rating



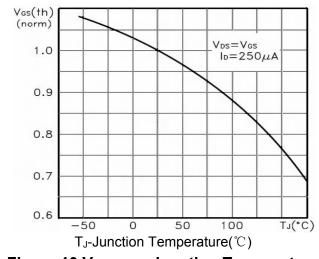
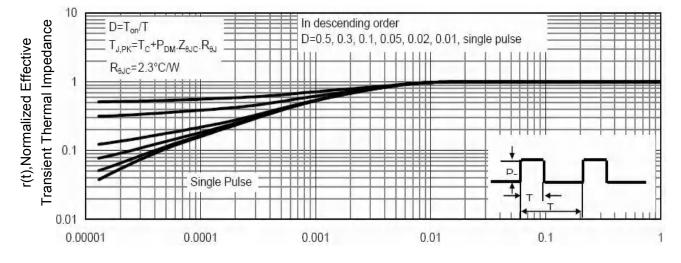


Figure 8 Safe Operation Area

Figure 10 V_{GS(th)} vs Junction Temperature

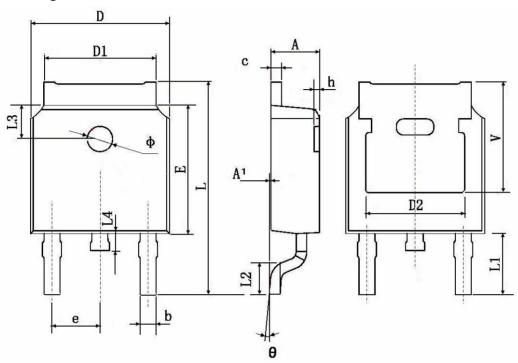


Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance



TO-252 Package Information



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | | |
|--------|---------------------------|------------|----------------------|------------|--|
| | Min. | Max. | Min. | Max. | |
| Α | 2.200 | 2.400 | 0.087 | 0.094 | |
| A1 | 0.000 | 0.127 | 0.000 | 0.005 | |
| b | 0.660 | 0.860 | 0.026 | 0.034 | |
| С | 0.460 | 0.580 | 0.018 | 0.023 | |
| D | 6.500 | 6.700 | 0.256 | 0.264 | |
| D1 | 5.100 | 5.460 | 0.201 | 0.215 | |
| D2 | 0.483 | 0.483 TYP. | | 0.190 TYP. | |
| E | 6.000 | 6.200 | 0.236 | 0.244 | |
| е | 2.186 | 2.386 | 0.086 | 0.094 | |
| L | 9.800 | 10.400 | 0.386 | 0.409 | |
| L1 | 2.900 TYP. | | 0.114 TYP. | | |
| L2 | 1.400 | 1.700 | 0.055 | 0.067 | |
| L3 | 1.600 TYP. | | 0.063 TYP. | | |
| L4 | 0.600 | 1.000 | 0.024 | 0.039 | |
| Ф | 1.100 | 1.300 | 0.043 | 0.051 | |
| θ | 0° | 8° | 0° | 8° | |
| h | 0.000 | 0.300 | 0.000 | 0.012 | |
| V | 5.350 TYP. | | 0.211 TYP. | | |



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